UNITED STATES PATENT AND TRADEMARK OFFICE **CERTIFICATE OF CORRECTION**

PATENT NO. : 7,121,919 B2 APPLICATION NO. : 09/944983

: October 17, 2006

INVENTOR(S)

DATED

: Farrar

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It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Page 1 of 2

On the Title page, in item (73), in "Assignee", in column 1, line 1, after "ID" insert -- 83716 --.

On the Title page, in item (56), under "Other Publications", in column 2, line 2, delete "Disclusures" and insert -- Disclosures --, therefor.

On page 2, in item (56), under "U.S. Patent Documents", in column 2, line 1, after "6,419,443" delete "B1 *" and insert -- B2 * --, therefor.

On page 2, in item (56), under "Other Publications", in column 2, line 4, delete "Planerization" and insert -- Planarization --, therefor.

On Sheet 7 of 9, in FIG. 11 (Reference Numeral 1118), line 1, delete "PLANERIZING" and insert -- PLANARIZING --, therefor.

On Sheet 7 of 9, in FIG. 12 (Reference Numeral 1218), line 1, delete "PLANERIZING" and insert -- PLANARIZING --, therefor.

On Sheet 8 of 9, in FIG. 14 (Reference Numeral 1457 (Top)), delete "1457" and insert -- 1454 --, therefor.

On Sheet 8 of 9, in FIG. 14 (Reference Numeral 1457 (Bottom)), delete "1457" and insert -- 1456 --, therefor.

Column 1, line 33, delete "resistive" and insert -- reactive --, therefor.

Column 1, line 34, delete "blanked" and insert -- blanket --, therefor.

Column 1, line 43, delete "buffering" and insert -- buffing --, therefor.

Column 9, line 20, delete "blank" and insert -- blanket --, therefor.

Column 18, line 38, in Claim 84, after "and" delete "the" and insert -- a front surface of a --, therefor.

Column 18, line 38, in Claim 84, after "platen" insert -- disposed to hold a wafer --.

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It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 18, line 42, in Claim 84, after "platen" insert -- holding the wafer --.

Signed and Sealed this

Twenty-second Day of May, 2007

JON W. DUDAS Director of the United States Patent and Trademark Office